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Class	Subclass	ISSUE CLASSIFICATION

PATENT NUMBER

U.S. UTILITY Patent Application

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APPLICATION NO.	CONT/PRIOR	CLASS	SUBCLASS	ART UNIT	EXAMINER
09/808790	D	025 438	691	3729	Vinh

1765

APPLICANTS
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TITLE
 Cluster tool systems and methods for processing wafers

PTO-2040
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ISSUING CLASSIFICATION

CLASS 025 438
 SUBCLASS 691
 ART UNIT 3729

NOTICE: THIS APPLICATION IS A CONTINUATION OF U.S. PATENT NO. 08/000,000

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